



STPS2L60/A

POWER SCHOTTKY RECTIFIER

MAIN PRODUCT CHARACTERISTICS

$I_F(AV)$	2 A
V_{RRM}	60 V
$T_j(max)$	150°C
$V_F(max)$	0.55 V

FEATURES AND BENEFITS

- NEGLIGIBLE SWITCHING LOSSES
- LOW FORWARD VOLTAGE DROP
- AVALANCHE CAPABILITY SPECIFIED

DESCRIPTION

Axial and Surface Mount Power Schottky rectifier suited for Switch Mode Power Supplies and high frequency DC to DC converters. Packaged in DO-41 and SMA, this device is intended for use in low voltage, high frequency inverters and small battery chargers.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter			Value	Unit
V_{RRM}	Repetitive peak reverse voltage			60	V
$I_F(RMS)$	RMS forward current			10	A
$I_F(AV)$	Average forward current	$T_L = 115^\circ\text{C} \quad \delta = 0.5$	SMA	2	A
		$T_L = 110^\circ\text{C} \quad \delta = 0.5$	DO-41		
I_{FSM}	Surge non repetitive forward current	$t_p = 10 \text{ ms}$ Sinusoidal		75	A
P_{ARM}	Repetitive peak avalanche power	$t_p = 1 \mu\text{s} \quad T_j = 25^\circ\text{C}$		1600	W
T_{stg}	Storage temperature range			- 65 to + 150	°C
T_j	Maximum junction temperature *			150	°C
dV/dt	Critical rate of rise of reverse voltage			10000	V/ μs

* : $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$ thermal runaway condition for a diode on its own heatsink

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THERMAL RESISTANCES

Symbol	Parameter			Value	Unit
$R_{th(j-l)}$	Junction to leads	Lead length = 10 mm	DO-41	30	$^{\circ}\text{C/W}$
			SMA	25	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Tests conditions		Min.	Typ.	Max.	Unit
I_R^*	Reverse leakage current	$T_j = 25^{\circ}\text{C}$	$V_R = 60\text{V}$			0.1	mA
		$T_j = 100^{\circ}\text{C}$			2	10	
V_F^*	Forward voltage drop	$T_j = 25^{\circ}\text{C}$	$I_F = 2\text{A}$			0.60	V
		$T_j = 125^{\circ}\text{C}$			0.51	0.55	
		$T_j = 25^{\circ}\text{C}$	$I_F = 4\text{A}$			0.77	
		$T_j = 125^{\circ}\text{C}$			0.62	0.67	

Pulse test : * $t_p = 380\text{ }\mu\text{s}$, $\delta < 2\%$

To evaluate the maximum conduction losses use the following equation:

$$P = 0.43 \times I_{F(AV)} + 0.06 \times I_{F(RMS)}^2$$

Fig. 1: Average forward power dissipation versus average forward current.

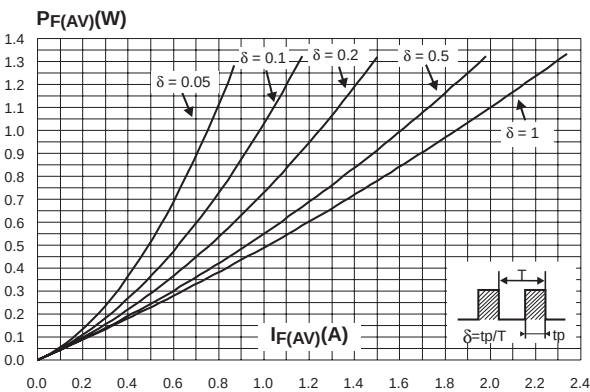


Fig. 2: Average forward current versus ambient temperature ($\delta = 0.5$).

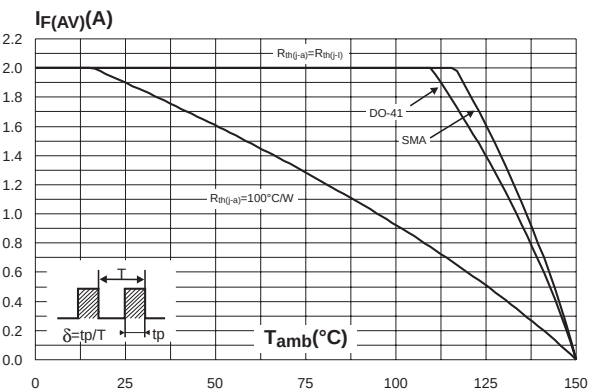


Fig. 3: Normalized avalanche power derating versus pulse duration.

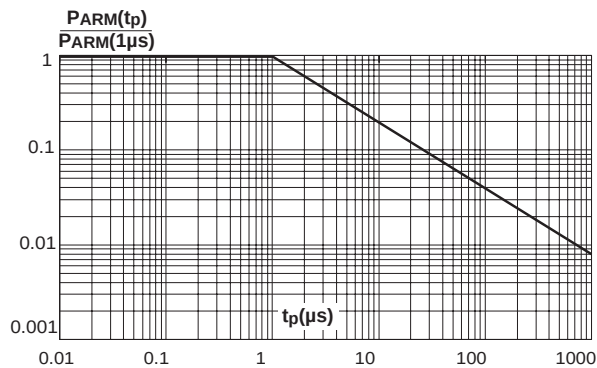


Fig. 4: Normalized avalanche power derating versus junction temperature.

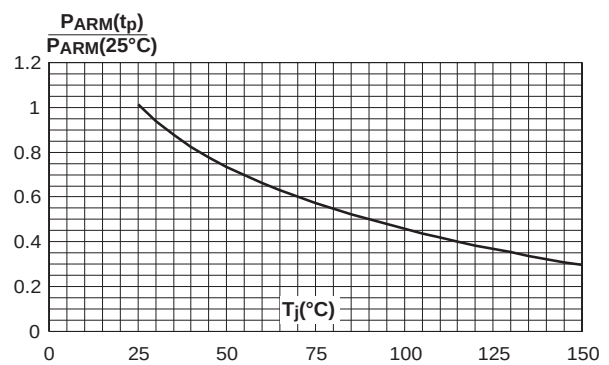


Fig. 5-1: Non repetitive surge peak forward current versus overload duration (maximum values) (DO-41).

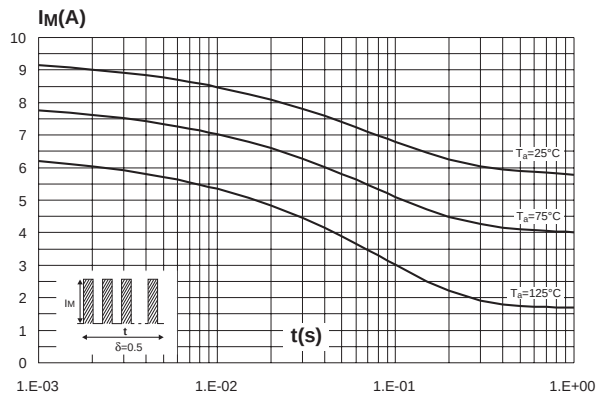


Fig. 5-2: Non repetitive surge peak forward current versus overload duration (maximum values) (SMA).

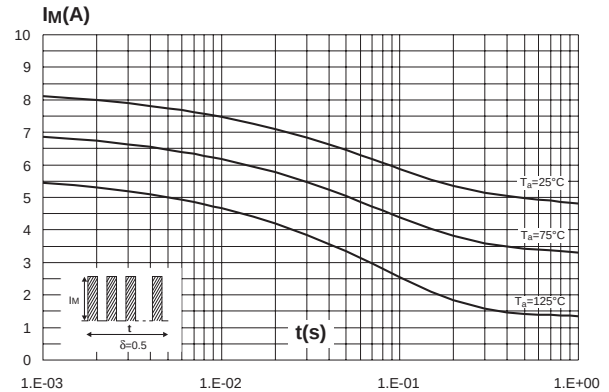


Fig. 6-1: Relative variation of thermal impedance junction to ambient versus pulse duration (DO-41).

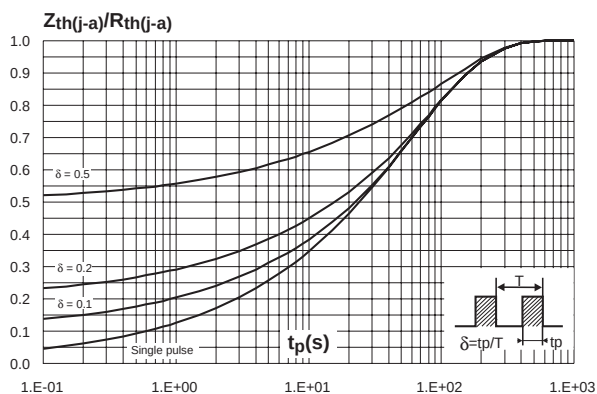


Fig. 6-2: Relative variation of thermal impedance junction to ambient versus pulse duration (SMA).

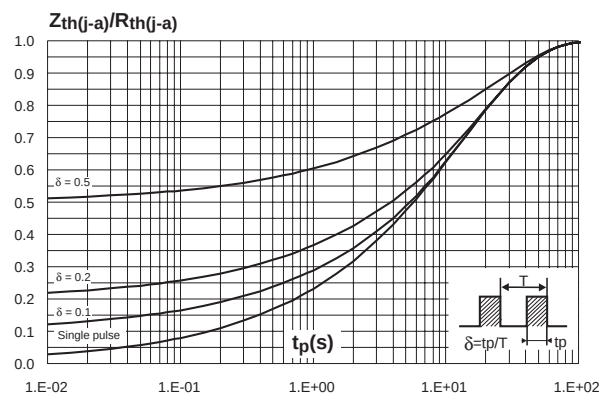


Fig. 7: Reverse leakage current versus reverse voltage applied (typical values).

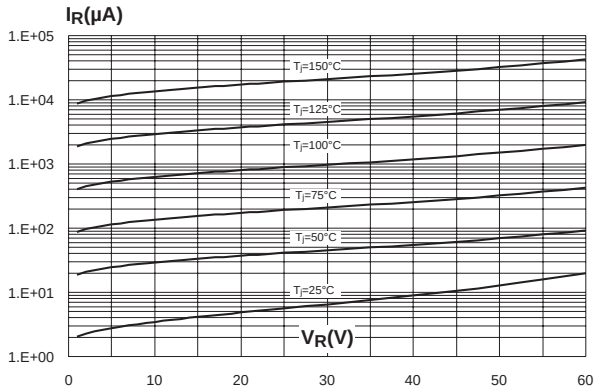


Fig. 8: Junction capacitance versus reverse voltage applied (typical values).

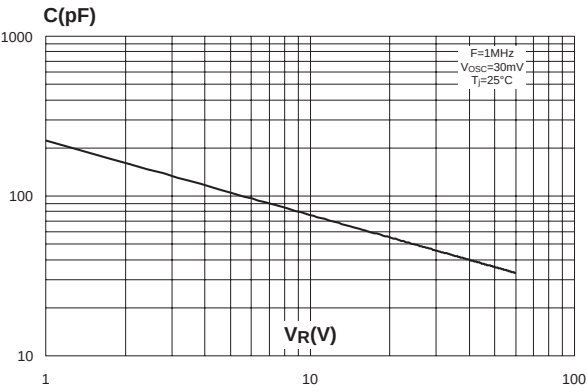


Fig. 9: Forward voltage drop versus forward current (low level, maximum values).

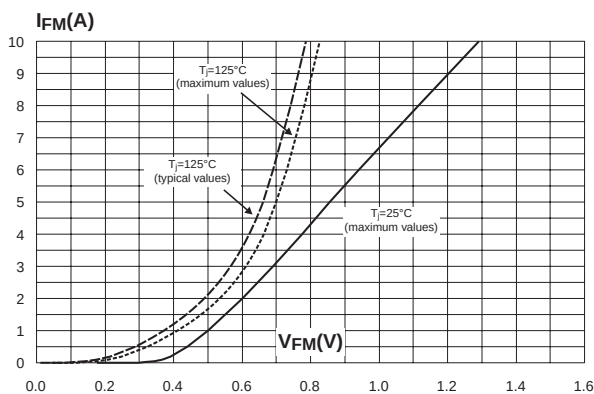


Fig. 10: Thermal resistance versus lead length (DO-41).

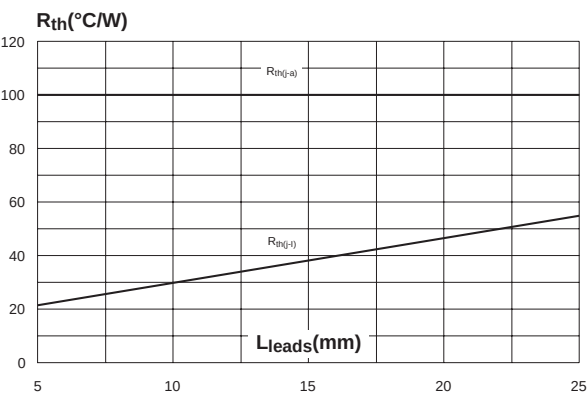


Fig. 11-1: Thermal resistance junction to ambient versus copper surface under each lead (Epoxy printed circuit board FR4, Cu: 35 μm) (SMA).

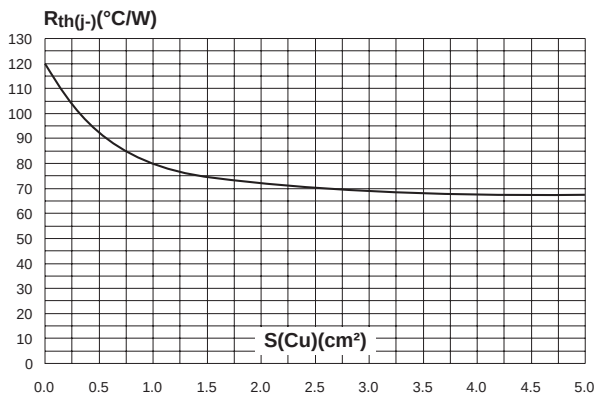
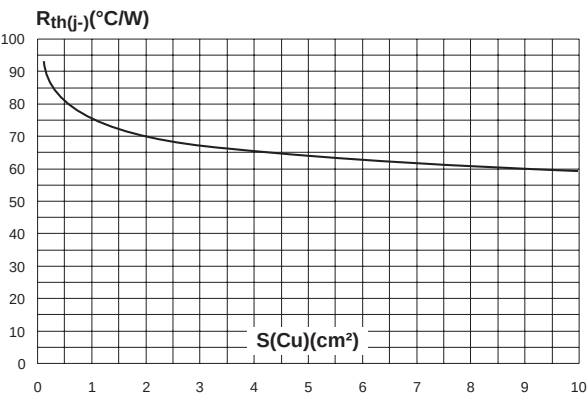
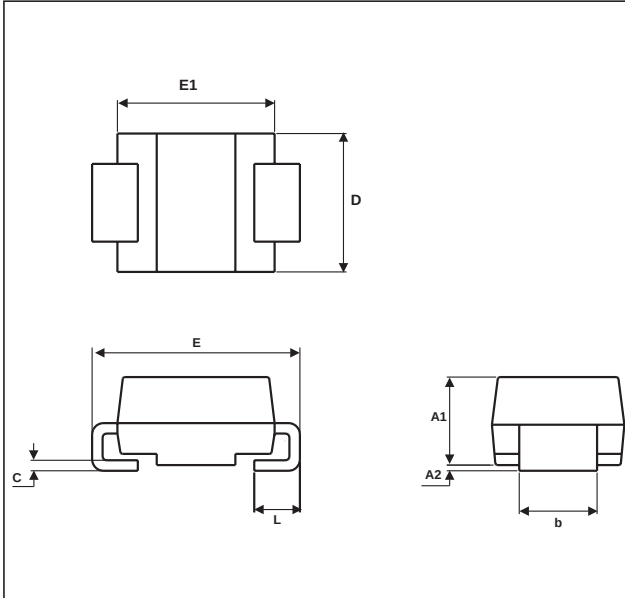


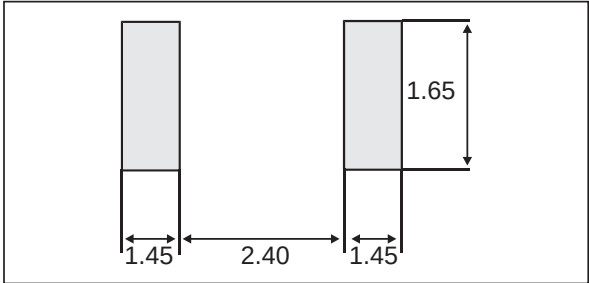
Fig. 11-2: Thermal resistance junction to ambient versus copper surface under each lead (Epoxy printed circuit board FR4, Cu: 35 μm) (DO-41).



PACKAGE MECHANICAL DATA
SMA (JEDEC DO-214AC)

	REF.	DIMENSIONS			
		Millimeters		Inches	
		Min.	Max.	Min.	Max.
A1		1.90	2.70	0.075	0.106
A2		0.05	0.20	0.002	0.008
b		1.25	1.65	0.049	0.065
c		0.15	0.41	0.006	0.016
E		4.80	5.60	0.189	0.220
E1		3.95	4.60	0.156	0.181
D		2.25	2.95	0.089	0.116

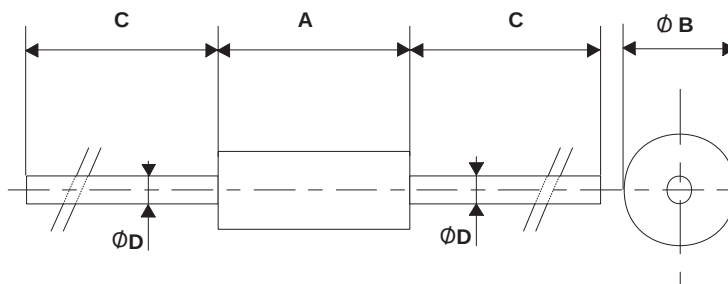
FOOT PRINT DIMENSIONS (in millimeters)



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PACKAGE MECHANICAL DATA

DO-41 plastic



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.07	5.20	0.160	0.205
B	2.04	2.71	0.080	0.107
C	28		1.102	

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS2L60	STPS2L60	DO-41	0.34g	2000	Ammopack
STPS2L60RL	STPS2L60	DO-41	0.34g	5000	Tape & Reel
STPS2L60A	S26	SMA	0.068 g	5000	Tape & Reel

- EPOXY MEETS UL94,V0

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